## Dangling Bond Logic:

 Designing Boolean Logic Gates on a $\mathrm{Si}(100)$-H surface

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## Outline

- Dangling Bonds (DBs) on semiconductor surfaces
- H -junction along a $\mathrm{Si}(100)-(2 \times 1)-\mathrm{H}$ atomic wire
- Boolean DB logic gates on $\mathrm{Si}(100)-(2 \times 1)-\mathrm{H}$ surface


## Manipulating single atoms using STM



Surface imaging tool based on quantum tunneling
Controllably manipulate atoms on a surface. Eigler, 1989


Selective removal of atoms with STM on $\mathrm{MoS}_{2}$

"NANO SPACE" written on $\mathrm{MoS}_{2}$ by removing surface $S$ atoms


Hosaka et al. J. Vac. Sci. Technol. 1995

Atomic line formed by removing surface $S$ atoms with an STM tip The de-passivated sites create dangling bonds (DBs)


## DBs on a $\mathrm{Si}(100)-(2 \times 1)-\mathrm{H}$ surface

Precise control
STM image of SiH surface with 4-DB cell with 2 perturbing DBs


Haider et al., PRL 2009


DBs closer to the diagonal perturb DBs

DB state within the $\mathrm{Si}(100)-(2 \times 1)-\mathrm{H}$ band gap


Calculated using VASP (DFT-PBE), $4 \times 2$ unit cell, 5 layers
Removing surface H atoms introduces states in the $\mathrm{Si}(100)$ surface band gap.
DB states are coupled to subsurface orbitals



## Bias dependence of the STM image of the $\mathrm{Si}(100)-\mathrm{c}(4 \times 2)$ surface



Filled-state STM images
Experimental ( 7 K ) Calculated (ESQC*)


Manzano et al., Phys. Rev. B 83, 201302 (2011)


- STM image and PDOS calculated using an Extended Hückel approximation fitted to DFT-PBE band structure
- STM image changes with bias because different states are probed: $p_{z}$ states dominate at small bias, $p_{x}$ states dominate at larger bias


DBs introduce $\pi$ and $\pi^{*}$ states in the gap, leading to $\pi$ and $\pi^{*}$ bands in a wire

## DB wires on $\mathrm{Si}(100)-(2 \times 1)-\mathrm{H}$

Parallel
DB wire parallel to dimer row
Unbuckled DB wire
Buckled DB wire perp to dimer row

$\Delta \mathrm{E}=0.81 \mathrm{eV}$

DBs on other semiconductor surfaces: Ge(100)


DBs on other semiconductor surfaces: $\mathrm{MoS}_{\mathbf{2}}$

Extraction of $S$ atoms

$\mathrm{MoS}_{2}$
$\mathrm{MoS}_{2}$ surface band structure
without atomic wire

$\mathrm{MoS}_{2}$ surface band structure with atomic wire



Removing an S atom introduces 3 states in the band gap

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## Quantum transport calculations



DB wires contacting a surface H -junction


Extended Hückel Hamiltonian to describe electronic structure Transmission coefficient, $T(E)$, from scattering calculations*



Transmission channels in wire direction within the energy gap DB wire band has a "2-channel" and "1-channel" region



## Transport along a DB wire contacted by metallic electrodes <br> 




Resonance peaks resulting from the DB states appear within the energy range of the infinite wire band

Tunneling through H-junction connected by a DB wire and metallic electrodes




Resonance peaks split, and splitting depends on the coupling through the H junction

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## Atom switching devices

## $\sum_{\text {AtMol }}^{8}$ Eas NUS



The switching atom is displaced from the atom wire by the electric field from the switching gate

Conceptually, logic circuits can be
 built using this concept


## DB Switches on a $\mathbf{S i}(100)$ surface




Does this concept work?


## DB Switch: T(E) and I-V curves



# Tight-binding model for DB switch 



Transport results from through-space and (more important) through-lattice coupling between DB pairs


Tight-binding model for DB switch





Qualitative agreement between TB model and full model.
TB model can be used to design large architectures.

## Switch contacted by parallel DB wires



The switch can be contacted by parallel DB wires and keep its function. This provides flexibility to position the electrodes


Decreased coupling with electrodes reduces ON current, and consequently the ON/OFF ratio.


## DB Logic AND gate on $\mathrm{Si}(100)-\mathrm{H}$



Switches connected in
(a)

(b)

series
a) Through Au nano-wire
b) Directly
c) Directly, and connected by parallel DB wires
(c)

(d)

| IN | OUT | Atomic structure | Classical structure |  |
| :--- | :--- | :---: | :---: | :---: |
| 00 | OFF | $\ldots$ |  |  |
| 10 | 1 | OFF | $\ldots$ |  |
| 11 | ON | $\ldots .$. |  |  |

= Add 2 H atoms


## DB Logic AND gate without central wire: $T(E)$ and I-V curves



## DB Logic NAND gate on $\mathbf{S i}(100)-\mathrm{H}$

(a)
(b)

Switches connected in parallel
a) By a "large" Au pad
b) By parallel DB wires

(c)

| IN | OUT | Atomic structure | Classical structure |
| :--- | :--- | :--- | :--- |
| 00 | ON | $\ldots$ |  |
| 01 | ON |  |  |
| 10 | 0 |  |  |
| 11 | OFF | $\ldots$ |  |



## DB Logic NAND gate: T(E) and I-V curves






## Conclusions

Dangling Bonds created on a $\mathrm{Si}(100)-\mathrm{H}$ surface introduce states in the surface band gap

Two types of atomic scale switches were constructed using these DB states, and connected by DB wires

Four Boolean Dangling Bond Logic gates ( 2 input/1 output) were designed on a $\mathrm{Si}(100)-\mathrm{H}$ surface, with ON/OFF ratio up to 100

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